

| | Type | L # | Hits | Search Text | DBs | Time Stamp | Co mm en ts | Er ro r De fi ni ti on | Er ro rs |
|---|------|-----|------|---|---|---------------------|----------------------|---|----------------|
| 1 | BRS | L1 | 2 | "6350673" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 17:41 | | | |
| 2 | BRS | L2 | 59 | (interconnect\$5 or metal) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:03 | | | |
| 3 | BRS | L3 | 69 | (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:21 | | | |

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| 4 | BRS | L5 | 0 | (438/225).ccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:06 | | | |
| 5 | BRS | L6 | 0 | (438/287).ccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:05 | | | |

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| 6 | BRS | L7 | 2 | (438/958).cccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:05 | | | |
| 7 | BRS | L8 | 0 | (438/255).cccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:06 | | | |

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| 8 | BRS | L9 | 0 | (257/E21.252).c cls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:06 | | | |
| 9 | BRS | L10 | 0 | (257/E21.627).c cls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:07 | | | |

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| 10 | BRS | L11 | 0 | (257/E21.614).c cls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:07 | | | |
| 11 | BRS | L12 | 3 | (257/E21.279).c cls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:09 | | | |

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| 12 | BRS | L13 | 20 | (257/E21.\$).ccl s. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:12 | | | |
| 13 | BRS | L14 | 24 | ("438"/\$).ccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:12 | | | |
| 14 | BRS | L15 | 40 | ("4113514" "4181751").PN. OR ("4331709").URP N. | US-PGPUB; USPAT; USOCR | 2006/08/20 19:14 | | | |

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| 15 | BRS | L4 | 4 | (438/619-662).ccls. and (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:16 | | | |
| 16 | BRS | L16 | 1 | (438/619-662).ccls. and (interconnect\$5 or metal or via or plug) and semiconductor and (hydrogen or h2 or "h.sub.2") near diffus\$5 with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:17 | | | |

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| 17 | BRS | L17 | 8 | (interconnect\$5 or metal or via or plug) and semiconductor and (hydrogen or h2 or "h.sub.2") near diffus\$5 with saturat\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:19 | | | |
| 18 | BRS | L18 | 9 | (interconnect\$5 or metal or via or plug) and semiconductor and (hydrogen or h2 or "h.sub.2") with diffus\$5 with saturat\$5 with bond | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:20 | | | |
| 19 | BRS | L19 | 11 | (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 with (bond or chc) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:25 | | | |

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| 20 | BRS | L20 | 1 | (interconnect\$5 or metal or via or plug) and semiconductor with (hydrogen or h2 or "h.sub.2") with saturat\$5 with chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:25 | | | |
| 21 | BRS | L21 | 1 | (interconnect\$5 or metal or via or plug) and semiconductor and (hydrogen or h2 or "h.sub.2") with saturat\$5 with chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:26 | | | |
| 22 | BRS | L22 | 1 | semiconductor and (hydrogen or h2 or "h.sub.2") with saturat\$5 with chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:27 | | | |
| 23 | BRS | L23 | 27 | (hydrogen or h2 or "h.sub.2") with saturat\$5 with chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:26 | | | |

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| 24 | BRS | L24 | 3 | semiconductor and (hydrogen or h2 or "h.sub.2") with saturat\$5 same chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:27 | | | |
| 25 | BRS | L25 | 16 | semiconductor and (hydrogen or h2 or "h.sub.2") with saturat\$5 and chc | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | 2006/08/20 19:27 | | | |